

**PDS5100Q** 

# 5A HIGH VOLTAGE SCHOTTKY BARRIER RECTIFIER POWERDI®5

#### **Product Summary**

| V <sub>R</sub> (V) | I <sub>F</sub> (A) | V <sub>F MAX</sub> (V)<br>@ +25°C | I <sub>R MAX</sub> (mA)<br>@ +25°C |
|--------------------|--------------------|-----------------------------------|------------------------------------|
| 100                | 5.0                | 0.79                              | 0.2                                |

#### **Features and Benefits**

- Guard Ring Die Construction for Transient Protection
- · High Surge Current Capability
- Low Leakage Current
- Low Forward Voltage Drop
- High Forward Surge Current Capability
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

### **Description and Applications**

This Schottky Barrier Rectifier is designed to meet the stringent requirements of automotive applications. It is ideally suited to use as:

- Polarity Protection Diode
- · Re-Circulating Diode
- Switching Diode

#### **Mechanical Data**

- Case: POWERDI<sup>®</sup>5
- Case Material: Molded Plastic, "Green" Molding Compound;
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe;
   Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Diagram
- Weight: 0.093 grams (Approximate)



RIGHT PIN O BOTTOMSIDE

Note: Pins Left & Right must be electrically connected at the printed circuit board.

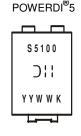
#### Ordering Information (Note 5)

| Part Number  | Compliance | Case                   | Packaging         |
|--------------|------------|------------------------|-------------------|
| PDS5100Q-13D | Automotive | POWERDI <sup>®</sup> 5 | 5,000/Tape & Reel |

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product\_compliance\_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.
- 6. "D" suffix designate for the 12mm Tape and Reel option.

### **Marking Information**



S5100 = Product type Marking Code
) | | = Manufacturers' Code Marking
YYWW = Date Code Marking
YY = Last Digit of Year (ex: 15 for 2015)
WW = Week Code (01 - 53)
K = Factory Designator



### Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

| Characteristic  | Symbol   | Value | Unit |
|---|--|-------|------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage              | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 100   | ٧    |
| RMS Reverse Voltage   | $V_{R(RMS)}$   | 71    | V    |
| Average Rectified Output Current  | lo   | 5     | Α    |
| Non-Repetitive Peak Forward Surge Current<br>8.3ms Single Half Sine-Wave Superimposed on Rated Load | I <sub>FSM</sub>                                       | 120   | А    |

#### **Thermal Characteristics**

| Characteristic   | Symbol                           | Тур    | Max  | Unit |
|--|----------------------------------|--------|------|------|
| Thermal Resistance Junction to Soldering Point                             | $R_{	heta JS}$                   | _      | 2.6  | °C/W |
| Thermal Resistance Junction to Ambient Air (Note 7) T <sub>A</sub> = +25°C | $R_{\theta JA}$                  | 90     | _    | °C/W |
| Thermal Resistance Junction to Ambient Air (Note 8) T <sub>A</sub> = +25°C | $R_{\theta JA}$                  | 70     | _    | °C/W |
| Thermal Resistance Junction to Ambient Air (Note 9) $T_A = +25^{\circ}C$   | $R_{\theta JA}$                  | 50     | _    | °C/W |
| Operating and Storage Temperature Range                                    | T <sub>J,</sub> T <sub>STG</sub> | -55 to | +150 | °C   |

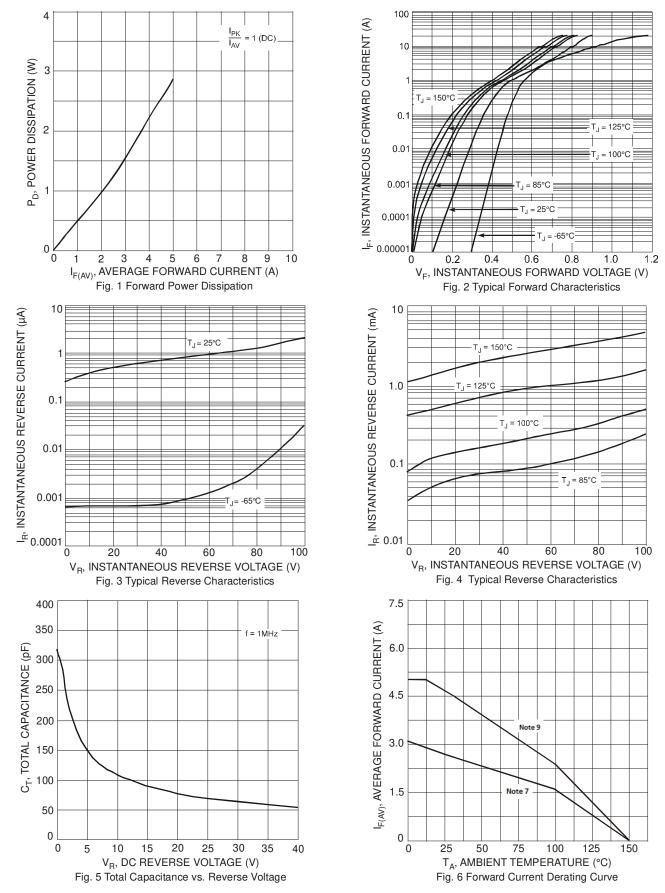
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                      | Symbol         | Min | Тур   | Max  | Unit | Test Condition                               |
|-------------------------------------|----------------|-----|-------|------|------|--|
| Reverse Breakdown Voltage (Note 10) | $V_{(BR)R}$    | 100 |       |      | V    | $I_R = 200 \mu A$                            |
|                                     |                |     | 0.74  | 0.79 | V    | $I_F = 5A, T_S = +25^{\circ}C$               |
|                                     | V <sub>F</sub> | _   | 0.64  | 0.68 |      | I <sub>F</sub> = 5A, T <sub>S</sub> = +100°C |
| Forward Voltage                     |                |     | 0.60  | 0.64 |      | $I_F = 5A, T_S = +125$ °C                    |
|                                     |                |     | 0.81  | 0.89 |      | $I_F = 10A, T_S = +25$ °C                    |
|                                     |                | _   | 0.68  | 0.73 |      | $I_F = 10A, T_S = +125$ °C                   |
|                                     | IR             | _   | 0.002 | 0.2  |      | $T_S = +25$ °C, $V_R = 100$ V                |
| Reverse Leakage Current (Note 10 )  |                | _   | 0.5   | 5    |      | $T_S = +100$ °C, $V_R = 100$ V               |
|                                     |                | _   | 2     | 20   |      | $T_S = +125^{\circ}C, V_R = 100V$            |

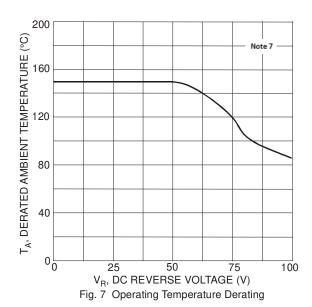
Notes:

- 7. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
  8. Polymide PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com.
  9. Polymide PCB, 2 oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
  10. Short duration pulse test used to minimize self-heating effect.





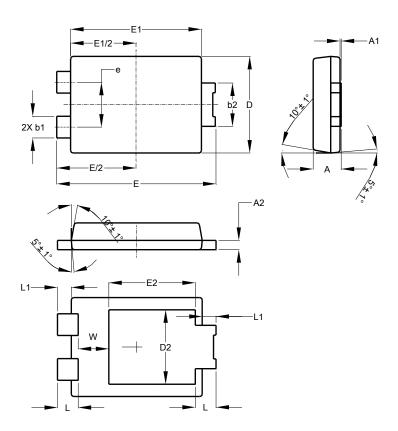






# **Package Outline Dimensions**

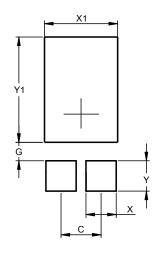
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



| POWERDI <sup>®</sup> 5 |      |      |       |  |
|------------------------|------|------|-------|--|
| Dim                    | Min  | Max  | Тур   |  |
| Α                      | 1.05 | 1.15 | 1.10  |  |
| <b>A</b> 1             | 0.00 | 0.05 | -     |  |
| A2                     | 0.33 | 0.43 | 0.381 |  |
| b1                     | 0.80 | 0.99 | 0.89  |  |
| b2                     | 1.70 | 1.88 | 1.78  |  |
| D                      | 3.90 | 4.05 | 3.966 |  |
| D2                     | -    | -    | 3.054 |  |
| Е                      | 6.40 | 6.60 | 6.504 |  |
| е                      | -    | -    | 1.84  |  |
| E1                     | 5.30 | 5.45 | 5.37  |  |
| E2                     | 1    | 1    | 3.549 |  |
| L                      | 0.75 | 0.95 | 0.85  |  |
| L1                     | 0.50 | 0.65 | 0.57  |  |
| W                      | 1.10 | 1.41 | 1.255 |  |
| All Dimensions in mm   |      |      |       |  |

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| С          | 1.840         |
| G          | 0.852         |
| Х          | 1.390         |
| X1         | 3.360         |
| Υ          | 1.400         |
| V1         | 4 860         |



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